

Features

- ◆ Optimized for LAN protection applications
- ◆ Ideal for ESD protection of data lines in accordance with IEC 1000-4-2(IEC801-2)
- ◆ Ideal for EFT protection of data lines in accordance with IEC 1000-4-4(IEC801-2)
- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◆ Glass passivated junction chip
- ◆ 1500w peak pulse power capability
- ◆ Excellent clamping capability
- ◆ Low incremental surge resistance
- ◆ Fast response time:typically less than 1.0ps from 0v to V_{BR} min
- ◆ AEC-Q101 qualified

Mechanical Data

Case : Molded plastic body

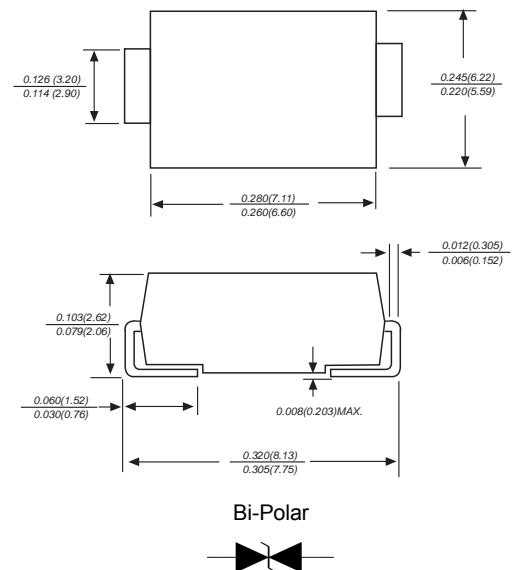
Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.008 ounce, 0.225 grams

DO-214AB/SMC



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	SYMBOLS	VALUE	UNITS
Peak pulse power dissipation with a 10/1000μs waveform(NOTE 1,2,FIG.1)	P _{PPM}	Minimum 1500	Watts
Peak forward surge current (Note 1,2,3)	I _{FSM}	200.0	Amps
Peak pulse current with a 10/1000μs waveform(NOTE 1)	I _{PPM}	See Table 1	Amps
Steady state power dissipation (Note 3)	P _D	6.5	Watts
Maximum instantaneous forward voltage at 50A(Note 3,4) unidirectional only	V _F	3.5	Volts
Operating junction and storage temperature range	T _{STG} ,T _J	-55 to + 150	°C

Notes:1.Non-repetitive current pulse,per Fig.3 and derated above T_A=25°C per Fig.2

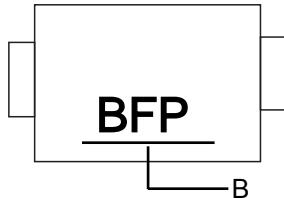
2.Mounted on 5.0mm copper pads to each terminal

3.Measured on 8.3ms single half sine-wave.For uni-directional devices only.

4.VF=3.5V on device.

Type	Marking	Peak Pulse Power	Stand-off Voltage	Maximum Reverse Current at VR	Breakdown Voltage at IT		Test Current	Maximum Peak Pulse Current	Maximum Clamping Voltage at Ipp
Bi-Polar	Bi-Polar	PPP	V(R)	IR	V(BR) (V)		IT	Ipp	Vc
		(W)	(V)	(uA)	Min.	Max.	(mA)	(A)	(V)
SM15T36CAY-CN	BFP	1500	36	1	40	44.2	1	25.9	58.1

Marking For Bi-Polar



Symbol	Explanation
B	Marking Code, as above sheet

Ratings And Characteristic Curves

Fig.1 Peak Pulse Power Rating Curve

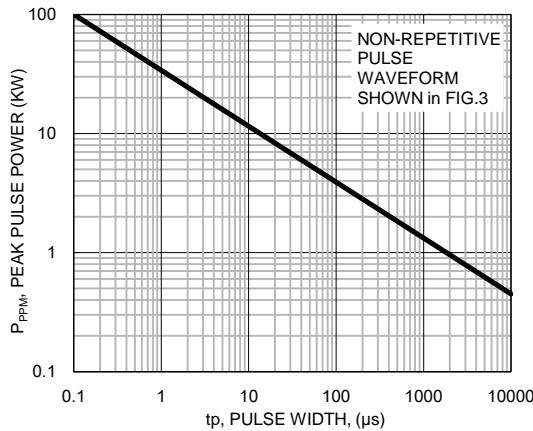


Fig.2 Pulse Derating Curve

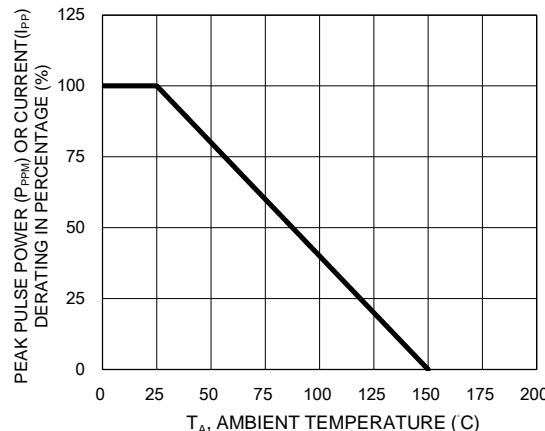


Fig.3 Clamping Power Pulse Waveform

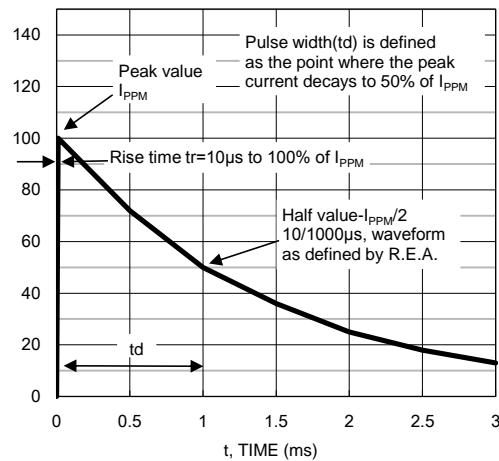


Fig.4 Typical Junction Capacitance

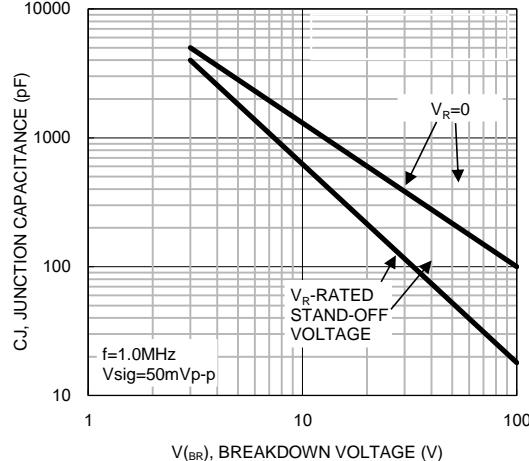
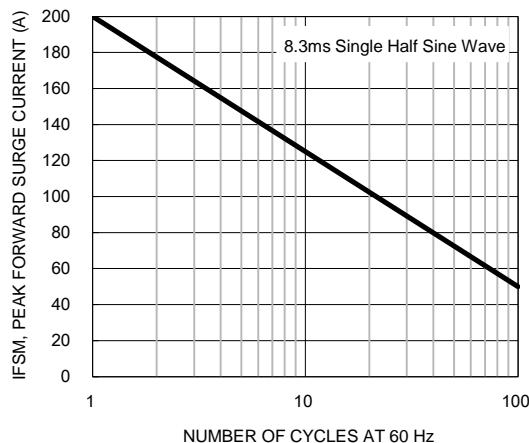
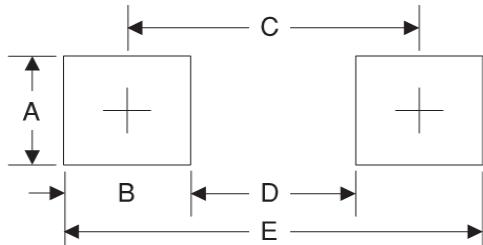


Fig.5 Maximum Non-repetitive Forward Surge Current Unidirectional Only

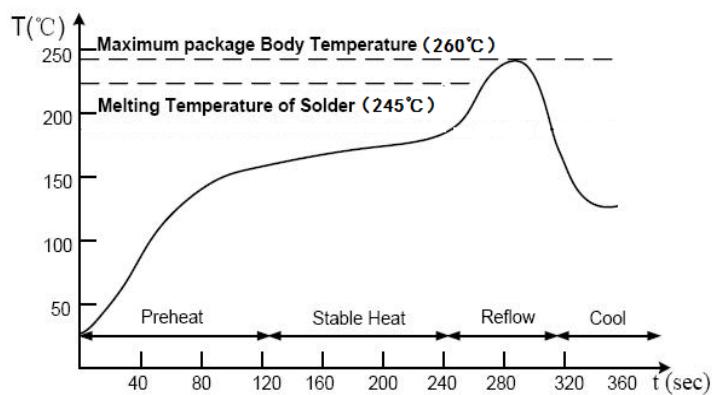


Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.80	0.268
D	4.40	0.173
E	9.40	0.370

Suggested Soldering Temperature Profile

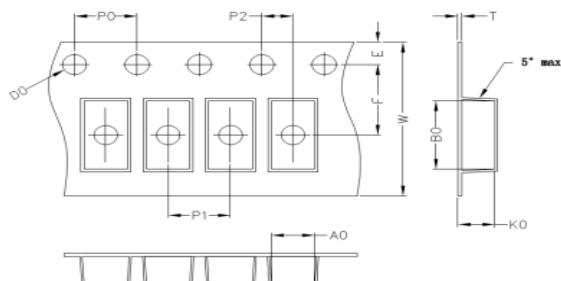


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Carrier Dimension(mm)



A0	B0	K0	D0	E	F
6.05	8.31	2.54	1.55	1.75	7.50
P0	P1	P2	T	W	Tolerance
4.0	8.0	2.0	0.25	16	0.1

Package Specifications

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
SMC	13'	330	3.0	340	6.0	360*360*360	48

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